Preferred Device

# Zener Transient Voltage Suppressor

# SOT-23 Dual Common Anode Zeners for ESD Protection

These dual monolithic silicon zener diodes are designed for applications requiring transient overvoltage protection capability. They are intended for use in voltage and ESD sensitive equipment such as computers, printers, business machines, communication systems, medical equipment and other applications. Their dual junction common anode design protects two separate lines using only one package. These devices are ideal for situations where board space is at a premium.

#### Features

- SOT-23 Package Allows Two Separate Unidirectional Configurations
- Low Leakage  $< 1 \ \mu A \ @ 5.0 \ V$
- Breakdown Voltage: 7.2–7.9 V @ 5 mA
- Low Capacitance (80 pF typical @ 0 V, 1 MHz)
- ESD Protection Meeting: 16 kV Human Body Model
- 30 kV Air and Contact Discharge
- Pb–Free Packages are Available

## **Mechanical Characteristics:**

- Void Free, Transfer–Molded, Thermosetting Plastic Case
- Corrosion Resistant Finish, Easily Solderable
- Package Designed for Optimal Automated Board Assembly
- Small Package Size for High Density Applications

#### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Power Dissipation @ 100 $\mu$ s (Note 1)	P <sub>pk</sub>	15	W
Steady State Power Dissipation Derate above 25°C (Note 2)	P <sub>D</sub>	225 1.8	mW mW/°C
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	556	°C/W
Maximum Junction Temperature	$R_{\thetaJA}$	417	°C/W
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	– 55 to +150	°C
ESD Discharge MIL STD 883C – Method 3015–6 IEC61000–4–2, Air Discharge IEC61000–4–2, Contact Discharge	V <sub>PP</sub>	16 30 30	kV

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

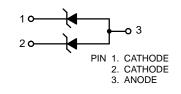
1. Non-repetitive 100 µs pulse width

2. Mounted on FR-5 Board = 1.0 X 0.75 X 0.062 in.



## **ON Semiconductor®**

http://onsemi.com

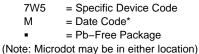




SOT-23 CASE 318 STYLE 12

### MARKING DIAGRAM





\*Date Code orientation and/or overbar may vary depending upon manufacturing location.

### **ORDERING INFORMATION**

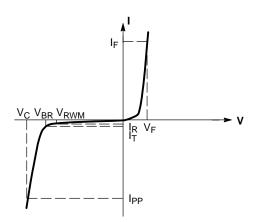
Device	Package	Shipping <sup>†</sup>
MA3075WALT1	SOT-23	3000/Tape & Reel
MA3075WALT1G	SOT-23 (Pb-Free)	3000/Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

**Preferred** devices are recommended choices for future use and best overall value.

### **ELECTRICAL CHARACTERISTICS**

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Forward Voltage	VF	I <sub>F</sub> = 10 mA		0.8	0.9	V
Zener Voltage*2	VZ	l <sub>Z</sub> = 5 mA	7.2	7.5	7.9	V
Operating Resistance	R <sub>ZK</sub>	l <sub>Z</sub> = 0.5 mA			120	Ω
	R <sub>Z</sub>	I <sub>Z</sub> = 5 mA		6	15	Ω
Reverse Current	I <sub>R1</sub>	V <sub>R</sub> = 5 V			1	μΑ
	I <sub>R2</sub>	V <sub>R</sub> = 6.5 V			60	μΑ
Temperature Coefficient of Zener Voltage <sup>*3</sup>	Sz	I <sub>Z</sub> = 5 mA	2.5	4.0	5.3	mV/°C
Terminal Capacitance	Ct	V <sub>R</sub> = 0 V		80		pF



Uni-Directional TVS

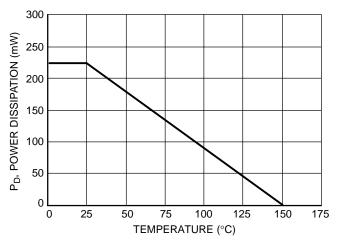


Figure 1. Steady State Power Derating Curve

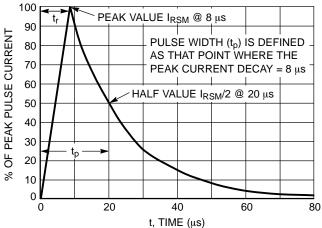
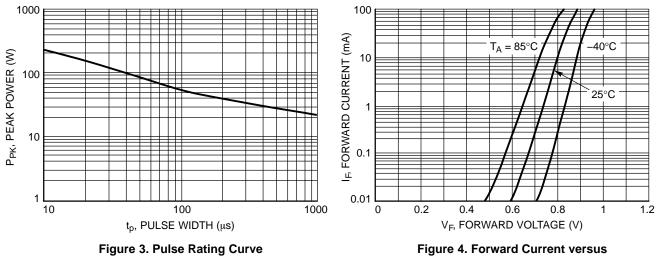
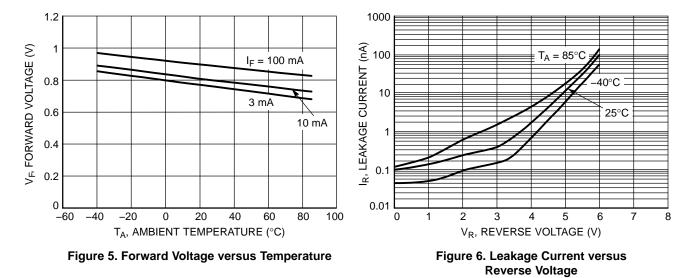
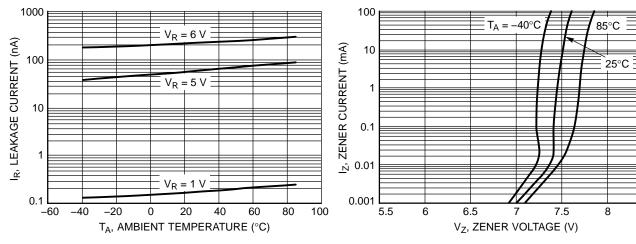


Figure 2. 8 X 20 µs Pulse Waveform



Forward Voltage



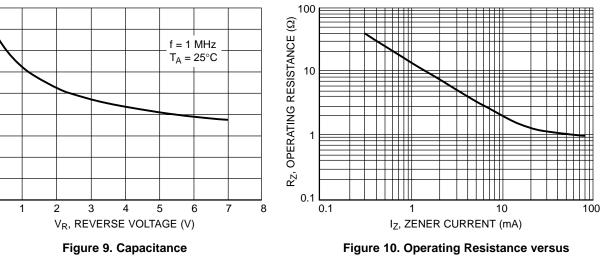




Cd, CAPACITANCE (pF)

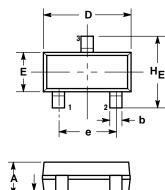
Figure 8. Zener Current versus Zener Voltage

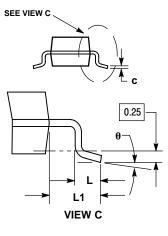
8.5



Zener Current

SOT-23 (TO-236) CASE 318-08 **ISSUE AN** 





NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. CONTROLLING DIMENSION: INCH.

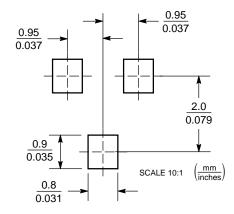
- 2 MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF 3.
- BASE MATERIAL. 318-01 THRU -07 AND -09 OBSOLETE, NEW 4. STANDARD 318-08.

	MILLIMETERS			INCHES			
DIM	MIN	NOM	MAX	MIN	NOM	MAX	
Α	0.89	1.00	1.11	0.035	0.040	0.044	
A1	0.01	0.06	0.10	0.001	0.002	0.004	
σ	0.37	0.44	0.50	0.015	0.018	0.020	
С	0.09	0.13	0.18	0.003	0.005	0.007	
D	2.80	2.90	3.04	0.110	0.114	0.120	
Е	1.20	1.30	1.40	0.047	0.051	0.055	
e	1.78	1.90	2.04	0.070	0.075	0.081	
Г	0.10	0.20	0.30	0.004	0.008	0.012	
L1	0.35	0.54	0.69	0.014	0.021	0.029	
HE	2.10	2.40	2.64	0.083	0.094	0.104	

STYLE 12: PIN 1. CATHODE 2. CATHODE

3 ANODE

#### **SOLDERING FOOTPRINT\***



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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